



Product data sheet

1. General description

Ultrafast epitaxial rectifier diode in a SOD113 (2-lead TO-220F) plastic package.

2. Features and benefits

- Fast switching
- Isolated package
- Low forward voltage drop
- Low thermal resistance
- Soft recovery characteristic

3. Applications

- High frequency switched-mode power supplies
- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions		Values			Unit
Absolute	e maximum rating						
V_{RRM}	repetitive peak reverse voltage			6	00		V
$I_{F(AV)}$	average forward current	δ = 0.5; square-wave pulse; T _h ≤ 115 °C; Fig. 1; Fig. 2	5		A		
I _{FRM}	repetitive peak forward current	δ = 0.5; square-wave pulse; T _h ≤ 115 °C	10			A	
I _{FSM} non-repetitive peak		t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	60		А		
	forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	66		А		
Symbol	Parameter	Conditions	Min Typ Max		Unit		
Static ch	aracteristics						
V _F	forward voltage	I _F = 5 A; T _j = 25 °C; <u>Fig. 4</u>		-	1.12	1.30	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 4</u>		-	0.97	1.11	V
Dynamic	characteristics	1		1	1		
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs; T _j = 25 °C; <u>Fig. 5</u>		-	50	60	ns

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	
2	A	anode		К_Ң_А
mb	n.c.	mounting base; isolated	SOD113 (2-lead TO-220F)	001aaa020

6. Ordering information

Table 3. Ordering information						
Type number	e number Package					
	Name	Description	Version			
BYV25X-600	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 2-lead TO-220 "full pack"	SOD113			

7. Marking

Table 4. Marking codes							
	Type number	Marking codes					
	BYV25X-600	BYV25X-600					

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V _{RRM}	repetitive peak reverse voltage		600	V
V _{RWM}	crest working reverse voltage		600	V
V _R	reverse voltage	δ = 1.0; square wave pulse; T _h ≤ 100 °C	600	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _h ≤ 115 °C; Fig. 1; Fig. 2	5	A
I _{FRM}	repetitive peak forward current	δ = 0.5; square-wave pulse; T _h ≤ 115 °C	10	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	60	А
	forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	66	А
T _{stg}	storage temperature		-40 to 150	°C
Tj	junction temperature		150	°C

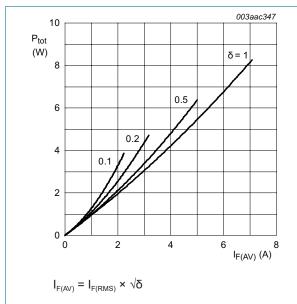


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

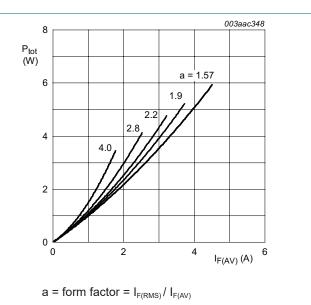
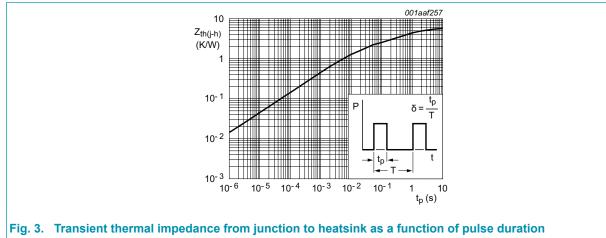


Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

9. Thermal characteristics

Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-h)}}$	thermal resistance	with heatsink compound; Fig 3	-	-	5.5	K/W
	from junction to heatsink	without heatsink compound	-	-	5.9	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W



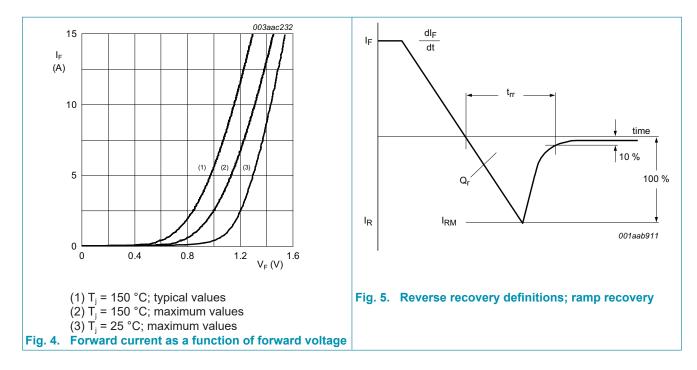
10. Isolation characteristics

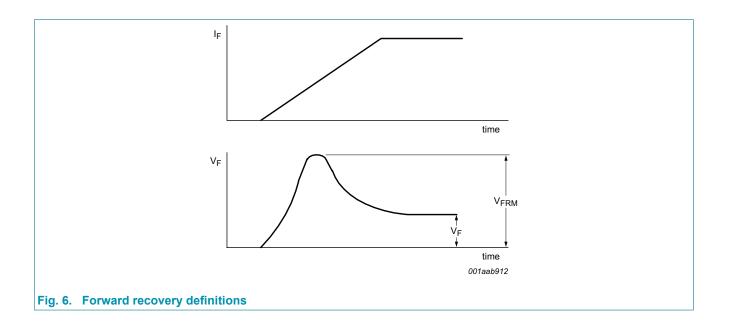
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{isol}(\text{RMS})}$	RMS isolation voltage	50 Hz \leq f \leq 60 Hz; RH \leq 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	f = 1 MHz; from cathode to external heatsink	-	10	-	pF

ambient

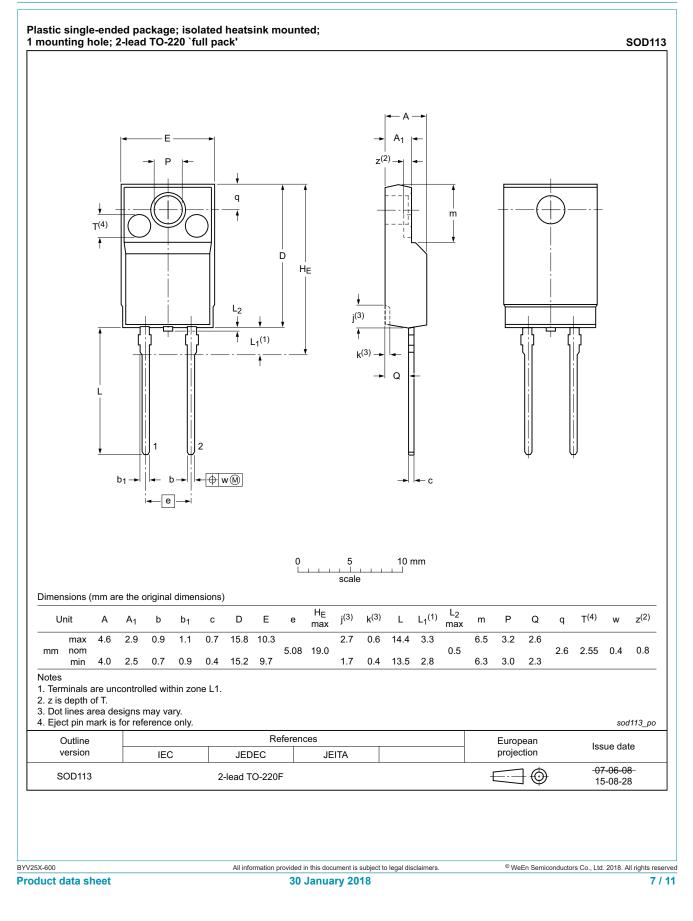
11. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	·				
V _F	forward voltage	I _F = 5 A; T _j = 25 °C; <u>Fig. 4</u>	-	1.12	1.30	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 4</u>	-	0.97	1.11	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	2	50	μA
		V _R = 600 V; T _j = 100 °C	-	0.1	0.35	mA
Dynamic	characteristics		I			
Q _r	recovered charge	$I_F = 2 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 20 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 5}$	-	40	70	nC
t _{rr}	reverse recovery time	$I_{F} = 1 \text{ A}; V_{R} = 30 \text{ V}; \text{ d}I_{F}/\text{d}t = 100 \text{ A}/\mu\text{s}; T_{j} = 25 \text{ °C}; Fig. 5$	-	50	60	ns
I _{RM}	peak reverse recovery current	$I_{F} = 10 \text{ A}; V_{R} = 30 \text{ V}; dI_{F}/dt = 50 A/\mu\text{s}; \\ T_{j} = 100 ^{\circ}\text{C}; \overline{\text{Fig. 5}}$	-	3	5.5	A
V_{FR}	forward recovery voltage	I _F = 10 A; dI _F /dt = 100 A/μs; T _i = 25 °C; <u>Fig. 6</u>	-	3.2	-	V





12. Package outline



13. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
BYV25X-600 v.2	20180130	Product data sheet	-	BYV25X-600_1		
Modifications:	Modifications: Change from NXP version to WeEn version					
BYV25X-600_1	20080812	Product data sheet	-	-		

BYV25X-600

Rectifier diode, ultrafast

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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